



NOTE(1):
020122MR008 □ 13ZA

1. Selective plating
 Ⓢ 'S1,-05u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 Ⓢ 'S3,-10u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 Ⓢ 'S4,-15u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 Ⓢ 'S5,-30u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 Ⓢ 'S6,-50u" Min. gold in contact area/
 100u" Min. Tin in solder area.

5	Top Shell	Stainless Steel	---	NI
4	Middle Shell	Stainless Steel	---	NI
3	Terminal	Phos.Bronze	---	GLD/TIN
2	Shell	Stainless Steel	---	NI
1	Plastic	LCP	BLACK	UL90V-0
NO.	DESCRIPTION	MATERIAL	COLOR	REMARK

SUYIN
CONNECTOR

CUSTOMER COPY	TITLE: USB Series A Type Dual Port Dip Type
PART NO.	020122MR008SX13ZA
PART NO. (OLD)	2522AY-08GXT-M
DRAWING NO.	D ING 020122MR008SX13ZA
SCALE	4:1
UNIT	mm
A4	⊕

ECN (DCN) NO.	REV	DATE	DESCRIPTION	CHANGE	APPRO.	GENERAL TOLERANCE UNLESS OTHERWISE NOTED
			C1:修改叉片結構;C2:叉片高度3.50→3.00			Angle ±2°
			B1: DEI 2522AY-08G2T-M	馬克鋒	陳清照	30 ~ ±0.50
EC1T-021114-07	A	02/11/14	A1:增加偷料孔;A2:修改鐵殼薄片;A3:16.25±0.10→16.25	宋勃逸	宋權哲	10 ~ 30 ±0.30
	O	01/06/22	NEW			~ 10 ±0.15

DRAW	李儒平	01/06/22
DESIGN	李儒平	01/06/22
CHECK	張志璋	01/06/22
APPRO.	張志璋	01/06/22